

MITSUBISHI RF POWER TRANSISTOR  
**2SC2609**

**NPN EPITAXIAL PLANAR TYPE**

**DESCRIPTION**

Mitsubishi 2SC2609 is a silicon NPN epitaxial planar type transistor specifically designed for VHF power amplifier applications.

**FEATURES**

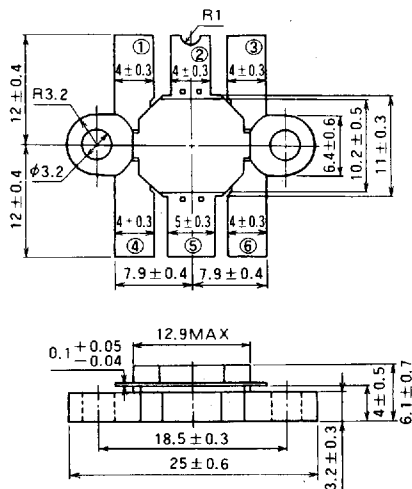
- High power gain:  $G_{pe} \geq 6.0\text{dB}$   
@ $V_{CC} = 28\text{V}$ ,  $P_O = 100\text{W}$ ,  $f = 220\text{MHz}$
- High ruggedness: Ability to withstand more than 20:1 load VSWR when operated at  $V_{CC} = 28\text{V}$ ,  $f = 220\text{MHz}$ ,  $P_O = 70\text{W}$

**APPLICATION**

For output stage of 100W power amplifiers VHF band.

**OUTLINE DRAWING**

Dimensions in mm



- Pin:
- ① EMITTER (FLANGE)
  - ② COLLECTOR
  - ③ EMITTER (FLANGE)
  - ④ EMITTER (FLANGE)
  - ⑤ BASE
  - ⑥ EMITTER (FLANGE)

**ABSOLUTE MAXIMUM RATINGS** ( $T_C = 25^\circ\text{C}$  unless otherwise specified)

Symbol	Parameter	Conditions	Ratings	Unit
$V_{CBO}$	Collector to base voltage		55	V
$V_{EBO}$	Emitter to base voltage		4	V
$V_{CEO}$	Collector to emitter voltage	$R_{BE} = \infty$	35	V
$I_C$	Collector current		15	A
$P_C$	Collector dissipation	$T_C = 25^\circ\text{C}$	170	W
$T_j$	Junction temperature		+175	$^\circ\text{C}$
$T_{stg}$	Storage temperature		-55 ~ +175	$^\circ\text{C}$

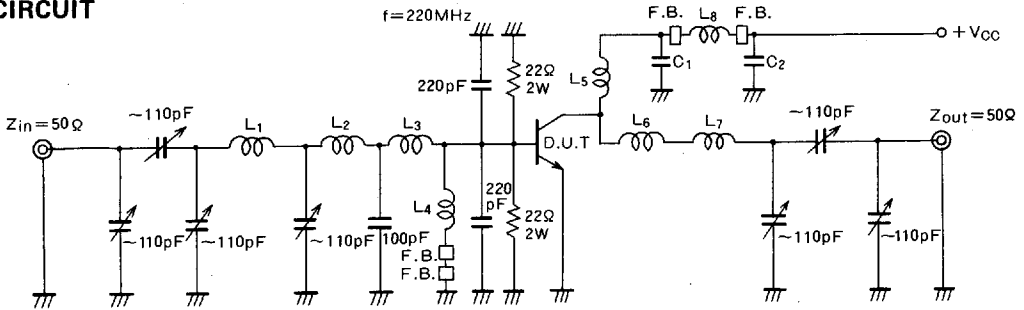
**ELECTRICAL CHARACTERISTICS** ( $T_C = 25^\circ\text{C}$  unless otherwise specified)

Symbol	Parameter	Test conditions	Limits			Unit
			Max	Typ	Min	
$V_{(BR)EBO}$	Emitter to base breakdown voltage	$I_E = 10\text{mA}$ , $I_C = 0$	4			V
$V_{(BR)CBO}$	Collector to base breakdown voltage	$I_C = 100\text{mA}$ , $I_E = 0$	55			V
$V_{(BR)CEO}$	Collector to emitter breakdown voltage	$I_C = 200\text{mA}$ , $R_{BE} = \infty$	35			V
$I_{CBO}$	Collector cut off current	$V_{BE} = 35\text{V}$ , $I_E = 0$			10	mA
$I_{EBO}$	Emitter cut off current	$V_{EB} = 3\text{V}$ , $I_C = 0$			4	mA
$h_{FE}$	DC forward current gain *	$V_{CE} = 25\text{V}$ , $I_C = 0.2\text{A}$	20	50	110	—
$P_O$	Power output	$V_{CC} = 28\text{V}$ , $f = 220\text{MHz}$ , $P_{in} = 25\text{W}$	100	110		W
$\eta_C$	Collector efficiency		55	60		%

\* Note: Pulse test,  $P_w = 150\mu\text{s}$ , duty = 5%.

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**TEST CIRCUIT**

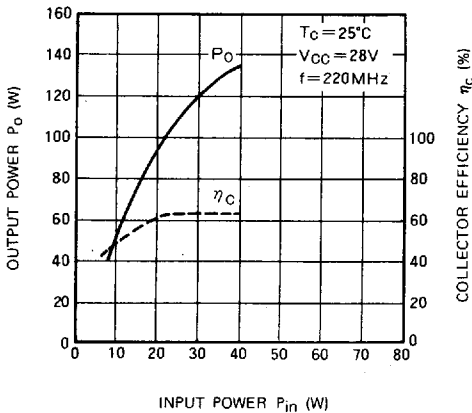


- L<sub>1</sub>: 10D, 1T, φ1.6 Ag-plated Cu wire.
- L<sub>2</sub>: Length 10, φ1.6 Ag-plated Cu wire.
- L<sub>3</sub>: Length 15, φ1.6 Ag-plated Cu wire.
- L<sub>4</sub>: 10D, 6T, 2P, φ1.6 Ag-plated Cu wire.
- L<sub>5</sub>: 10D, 5T, 3P, φ1.6 Ag-plated Cu wire.
- L<sub>6</sub>: Length 20, Width 4, Thickness 0.2 Copper plate.
- L<sub>7</sub>: Length 27, φ1.6 Ag-plated Cu wire.
- L<sub>8</sub>: 8D, 20T, 1P, φ0.8 Enamelled wire.

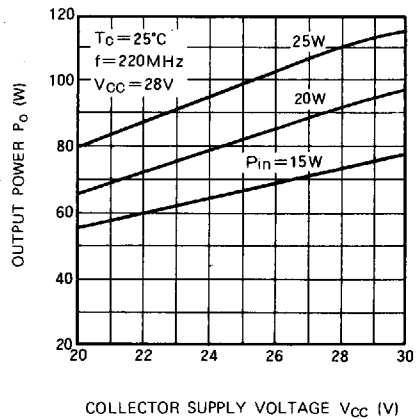
- C<sub>1</sub>: 1000pF, 3300pF, 0.1μF, 4.7μF, in parallel.
  - C<sub>2</sub>: 1000pF, 3300μF, 0.1μF, 4.7μF, in parallel.
  - B.F.: Ferrite Bead  
inside diameter 1.35,  
outside diameter 3.5,  
length 3.0.
- (Note) Dimensions: mm  
 D : inner diameter of coil.  
 T : turn numbers of coil.  
 P : pitch of coil.

**TYPICAL PERFORMANCE DATA**

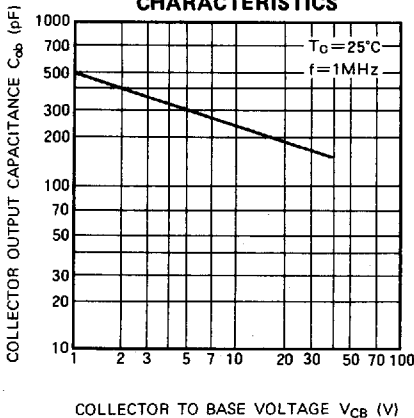
**OUTPUT POWER,  
 EFFICIENCY  
 VS. INPUT POWER**



**OUTPUT POWER VS.  
 COLLECTOR SUPPLY VOLTAGE**



**COLLECTOR OUTPUT  
 CAPACITANCE VS. COLLECTOR  
 TO BASE VOLTAGE  
 CHARACTERISTICS**



**INPUT IMPEDANCE  
 VS. FREQUENCY**

